DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

	the original, first and sole invent es are listed below) of the subject				
REFLOY	W SOLDERING APPARATUS				
the specificati	on of which is attached hereto un	less the following is ch	ecked		
was filed o	on MAY 1, 2003 as United State	s Application Number	or PCT International		
Application	n Number PCT/JP03/05589 and	was amended on	(if applicable).		
	that I have reviewed and understanced by any amendment referr		above-identified specification	, including the	
I acknowledge Regulations, §	e the duty to disclose information § 1.56.	which is material to pa	atentability as defined in Title	37, Code of Federal	
for patent or is	n foreign priority benefits under T nventor's certificate listed below tificate having a filing date before	and have also identifie	d below any foreign application	on for patent or	
		e that of the application	for which priority is claimed.	. Priority Claimed	
(List prior foreign applications. See		Ionon	16/5000	My. On	
note A)	2002-141237 (Number)	Japan (Country)	16/5/2002 (Day/Month/Year Filed)	⊠ Yes ∐ No	
,	2002-288548	Ionan	1/10/2002	M vas C Na	
	(Number)	Japan (Country)	(Day/Month/Year Filed)	⊠ Yes □ No	
			_	·	
	2003-109942 (Number)	Japan (Country)	15/4/2003 (Day/Month/Year Filed)	Yes No	
	(rumocr)	(Country)	(Day/Monul/Teal Flied)		
	2003-110130	Japan	15/4/2003	Yes □ No	
(Saa noto D)	(Number)	(Country)	(Day/Month/Year Filed)		
(See note B)		additional prior foreign	applications		
insofar as the s in the manner information w	the benefit under Title 35, Unite subject matter of each of the clain provided by the first paragraph of hich is material to patentability a ween the filing date of the prior	ns of this application is of Title 35, United Stat as defined in Title 37, (s not disclosed in the prior Un es Code, § 112, I acknowledg Code of Federal Regulations,	ited States application ge the duty to disclose § 1.56 which became	
(List prior U.S.			Stat	Status	
Applications)	(Application Serial No.)	(Filing Date)	Patented Pend	ling Abandoned	
			☐ Patented ☐ Pend	ling Abandoned	
	(Application Serial No.)	(Filing Date)		mie 🔲 Vognaniea	
			Patented Pend	ling Abandoned	
	(Application Serial No.)	(Filing Date)			

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

23850 PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

23850 PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, ' 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

See note C)	Inventor's signature	first inventor (given name, family name)	Date October 15, 2004	
•	Residence	Same as the Post Office Address	Citizenship	Japanese
	Post Office Address	2-5, Shiroyamate 2-chome, <u>Hachioji</u>		
	Full name of second Inventor's signature	inventor (given name, family name)	Date	
	Residence		Citizenship	
	Post Office Address			
	Full name of third inv Inventor's signature	ventor (given name, family name)	Date	
	Residence		Citizenship	
	Post Office Address			
		nventor (given name, family name)		
	Inventor's signature		Date	
	Residence Post Office Address		Citizenship	
	Full name of fifth inv Inventor's signature	entor (given name, family name)	Date	
	Residence		Citizenship	
	Post Office Address			

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